AUG 2 8 2006

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Masahiko HIRATA et al

Application No: 10/533,288

Art Unit: 1742

Filing date:

November 3, 2005 Examiner: Sikyin Ip

For:

LEAD-FREE SOLDER AND SOLDERED ARTICLE

<u>AMENDMENT</u>

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

In response to the Official Action mailed on March 27, 2006 the Applicants petition for a two-month extension of time, extending the period for response to and including August 28, 2006, submit the requisite fee therefor, and request that the present application be amended as shown below:

1068 -1-